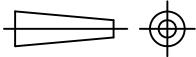
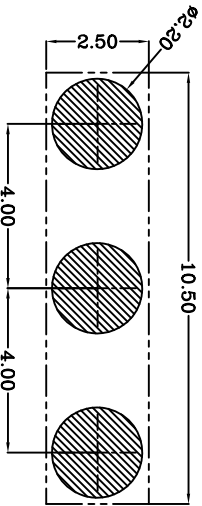
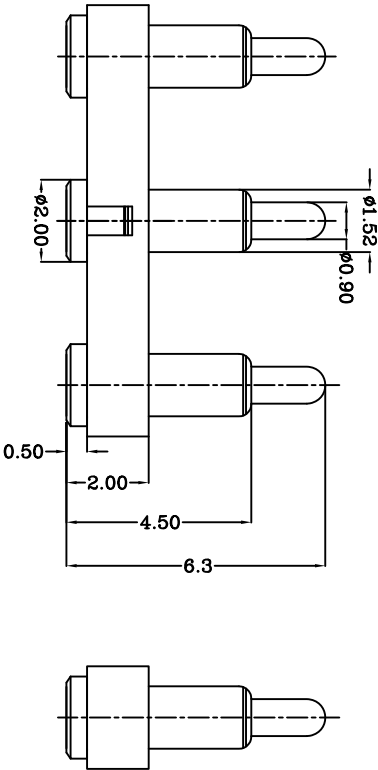
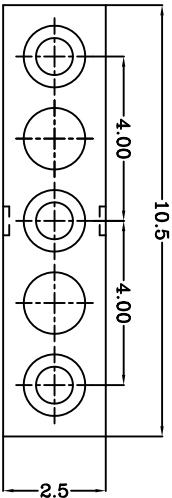


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DWG NO.
C-110867



Recommended PCB Layout

Recommended solder patse thickness is 0.10 mm

TOP-LINK

Notes:

1)Material(材质):

Housing: HTN, UL94 V-0 Color Black.

Contact: Brass

Spring :Stainless steel wire

2 Plating:

1)Body: Min 0.1um Gold plating over min. 1.4um Nickel plating
(Body: 镀金0.1um Min 镍底1.4um Min)

2)Plunger: Min 0.4um Gold plating over min. 1.4um Nickel plating
(Plunger: 镀金0.4um Min 镍底1.4um Min)

3 Mechanical:

Total stroke(总行程): 1.70mm

Durability(寿命): 10,000 cycle min.

4 Electrical(电性能)

Contact resistance(接触阻抗): 30mOhm Max.

Voltage rating(额定电压): 36V DC Max

Current rating(额定电流): 2.0A

USED ON

-

110867-3
PART NUMBER

DIMENSIONS IN MM			
TOLERANCES UNLESS			
OTHER SPECIFIED			
0	= ±		
0.0	= ±0.15		
0.00	= ±0.10		
0.000	= ±		
ANGLE: ±1°			

SURF TEXTURE:			
32/			
REMOVE BURRS, BREAK			
SHARP EDGES R0.05 MAX			
DO NOT SCALE PRINT			

NEW		2009/11/05	
REVISION			
RECORD			
APVD			
DATE			

LDC	-
DIST	-

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